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We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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### KSC5047

### **Feature**

- · High Current Gain
- Low Collector Emitter Saturation Voltage



### **NPN Epitaxial Silicon Transistor**

### **Absolute Maximum Ratings** $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	100	V
$V_{CEO}$	Collector-Emitter Voltage	50	V
V <sub>EBO</sub>	Emitter-Base Voltage	15	V
I <sub>C</sub>	Collector Current	15	Α
I <sub>B</sub>	Base Current	4	Α
P <sub>C</sub>	Collector Dissipation (T <sub>C</sub> =25°C)	100	W
TJ	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	- 55 ~ 150	°C

### **Electrical Characteristics** $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	$I_C = 50 \text{mA}, I_B = 0$	50			V
I <sub>CBO</sub>	Collector Cut-off Current	$V_{CB} = 100V, I_{E} = 0$			100	μΑ
I <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$V_{EB} = 15V, I_{C} = 0$			100	μΑ
h <sub>FE</sub>	DC Current Gain	$V_{CE} = 5V, I_{C} = 5A$	40			
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	$I_C = 5A, I_B = 0.12A$			0.5	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	$I_C = 5A, I_B = 0.12A$			1.2	V
t <sub>ON</sub>	Turn On Time	$V_{CC} = 20V, I_C = 5A$		0.5		μs
t <sub>STG</sub>	Storage Time	$I_{B1} = -I_{B2} = 0.12A$		2.5		μs
t <sub>F</sub>	Fall Time	$R_L = 4\Omega$		0.5		μs

# **Typical Characteristics**

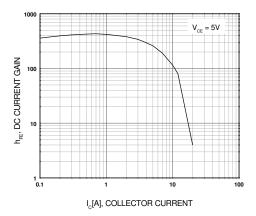


Figure 1. DC current Gain

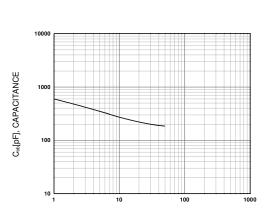


Figure 3. Collector Output Capacitance

 $V_{\text{CB}}[V], \, \text{COLLECTOR-BASE} \, \, \text{VOLTAGE}$ 

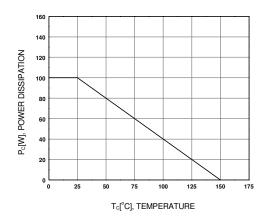


Figure 5. Power Derating

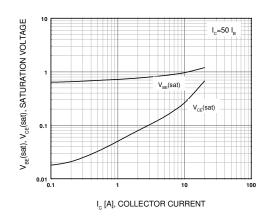


Figure 2. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

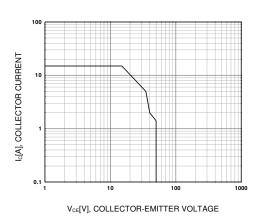
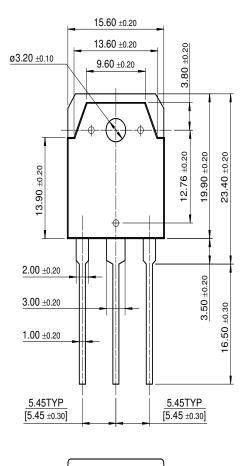
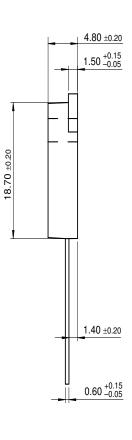


Figure 4. Safe Operating Area

# **Package Dimensions**

# TO-3P





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Rev. I1

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